

## ST13007DFP

# HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- IMPROVED SPECIFICATION:
  - LOWER LEAKAGE CURRENT
  - TIGHTER GAIN RANGE
  - DC CURRENT GAIN PRESELECTION
  - TIGHTER STORAGE TIME RANGE
- HIGH VOLTAGE CAPABILITY
- INTEGRATED FREE-WHEELING DIODE
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED
- FULLY CHARACTERIZED AT 125 °C
- LARGE RBSOA
- FULLY INSULATED PACKAGE (U.L. COMPLIANT) FOR EASY MOUNTING

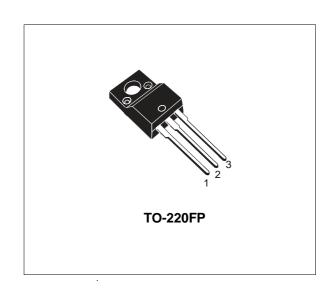


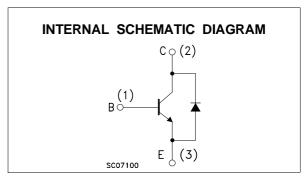
- UP TO 120W ELECTRONIC TRANSFORMERS FOR HALOGEN LAMPS
- SWITCH MODE POWER SUPPLIES



The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and high voltage capability.

It uses a Cellular Emitter structure to enhance switching speeds.





#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
$V_{CEV}$	Collector-Emitter Voltage (V <sub>BE</sub> = -1.5V) 700		V
$V_{CEO}$	Collector-Emitter Voltage (I <sub>B</sub> = 0)	400	V
$V_{EBO}$	Emitter-Base Voltage (I <sub>C</sub> = 0)	9	V
Ic	Collector Current	8	А
I <sub>CM</sub>	Collector Peak Current	16	А
$I_B$	Base Current	4	Α
$I_{BM}$	Base Peak Current	8	А
P <sub>tot</sub>	Total Dissipation at T <sub>c</sub> ≤ 25 °C	36	W
V <sub>isol</sub>	Insulation Withstand Voltage (RMS) from All Three Leads to External Heatsink	1500	V
T <sub>stg</sub>	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

May 2003 1/7

#### THERMAL DATA

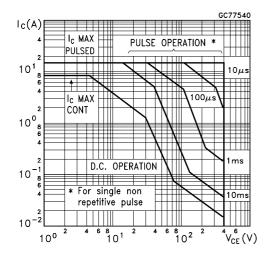
R <sub>thj-case</sub>	Thermal Resistance Junction-case	Max	3.47	°C/W
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max	62.5	°C/W

## **ELECTRICAL CHARACTERISTICS** ( $T_{case} = 25$ $^{\circ}C$ unless otherwise specified)

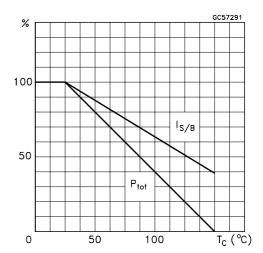
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Ices	Collector Cut-off Current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V			10 0.5	μA mA
I <sub>CEO</sub>	Collector Cut-off Current (I <sub>B</sub> = 0)	V <sub>CE</sub> = 400 V			100	μΑ
I <sub>EBO</sub>	Emitter Cut-off Current (I <sub>C</sub> = 0)	V <sub>EB</sub> = 9 V			100	μΑ
V <sub>CEO(sus)*</sub>	Collector-Emitter Sustaining Voltage (I <sub>B</sub> = 0)	I <sub>C</sub> = 10 mA	400			V
V <sub>CE(sat)</sub> *	Collector-Emitter Saturation Voltage	$\begin{split} I_C &= 2 \ A & I_B &= 0.4 \ A \\ I_C &= 5 \ A & I_B &= 1 \ A \\ I_C &= 8 \ A & I_B &= 2 \ A \\ I_C &= 5 \ A & I_B &= 1 \ A & T_c &= 100 \ ^{\circ}C \end{split}$			0.8 1.5 2 3	> > >
V <sub>BE(sat)</sub> *	Base-Emitter Saturation Voltage	$ \begin{aligned} &I_{C} = 2 \text{ A} & &I_{B} = 0.4 \text{ A} \\ &I_{C} = 5 \text{ A} & &I_{B} = 1 \text{ A} \\ &I_{C} = 5 \text{ A} & &I_{B} = 1 \text{ A} & &T_{c} = 100 \end{aligned} $			1.2 1.6 1.5	< < <
h <sub>FE</sub> *	DC Current Gain	$\begin{aligned} & I_{C} = 2 \text{ A} & & V_{CE} = 5 \text{ V} \\ & I_{C} = 5 \text{ A} & & V_{CE} = 5 \text{ V} \end{aligned}$	18 8		40 25	
V <sub>f</sub>	Diode Forward Voltage	I <sub>C</sub> = 3 A			2.5	٧
t <sub>s</sub>	INDUCTIVE LOAD Storage Time Fall Time	$I_{C} = 5 \text{ A}$ $V_{CL} = 250 \text{ V R}_{BB} = 0\Omega$ $I_{B1} = 1 \text{ A}$ $V_{BE(off)} = -5 \text{ V}$ $L = 200 \mu\text{H}$ (see figure 1)		1.7 90	2.3 150	μs ns
ts tf	INDUCTIVE LOAD Storage Time Fall Time	$\begin{array}{llllllllllllllllllllllllllllllllllll$		2.2 150		μs ns

<sup>\*</sup> Pulsed: Pulse duration = 300 μs, duty cycle 2 %.

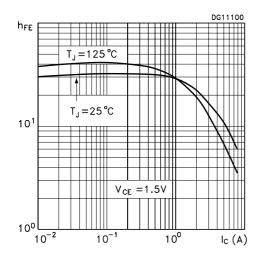
#### Safe Operating Area



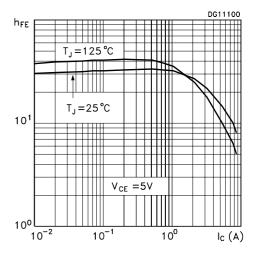
#### **Derating Curve**



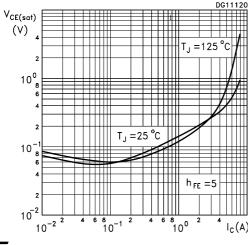
DC Current Gain



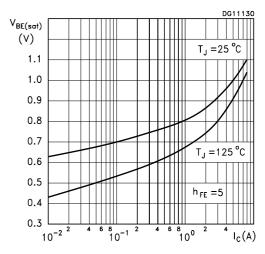
DC Current Gain



Collector Emitter Saturation Voltage

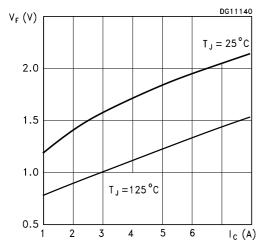


Base Emitter Saturation Voltage

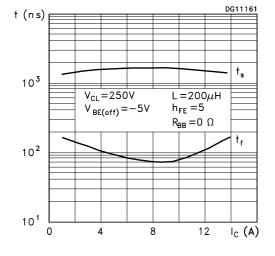


#### ST13007DFP

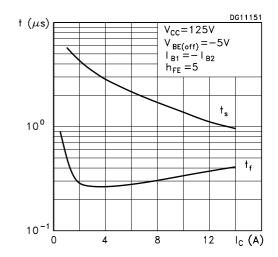
#### Diode Forward Voltage



# Switching Time Inductive Load



#### Switching Time Resistive Load



#### Reverse Biased SOA

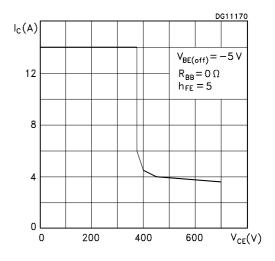


Figure 1: Inductive Load Switching Test Circuit.

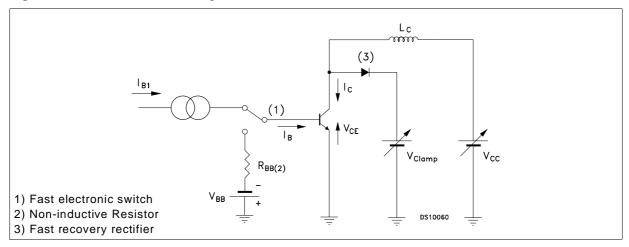
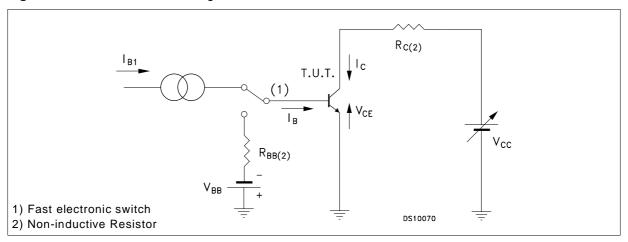
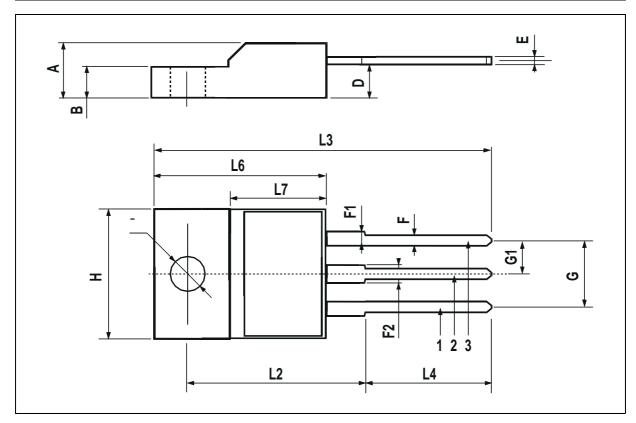


Figure 2: Resistive Load Switching Test Circuit.



## **TO-220FP MECHANICAL DATA**

DIM.		mm			inch	
DIIVI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.4		4.6	0.173		0.181
В	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
Н	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626	0.645	
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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